

- () Preliminary Specifications(V) Final Specifications

Module	11.6"(11.57") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B116XW02 V0 (H/W:0A)
Note (🔒)	LED Backlight with driving circuit design

Customer	Date					
Checked & Approved by	Date					
Note: This Specification is subject to change without notice.						

Approved by	Date					
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NBBU Marketing Division AU Optronics corporation						



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Record of Revision

Ver	sion and Date	Page	e Old description						New Description					Remark
0.1	2008/12/26	All	First Edition	First Edition for Customer										
0.2	2009/01/07	1	Module: 11.6	Module: 11.6"						Module: 11.6" (11.57")				
		34	EDID: TBD					EDIE):Adde	d				Added
0.3	2009/02/13	6	Response Ti	me				Resp	onse 7	ime				Updated
			Rising: TBD	(typ),	TBD(n	nax)		Risin	ıg: 6ms	s(typ),	8ms(n	nax)		
			Falling: TBD	(typ),	TBD(ı	max)		Falli	- ոց։ 2m	s(typ),	4ms(ı	max)		
		15	LED Power (Life-Time	Consu	mptio	n and	LED		Power Time	Cons	umptic	n and	LED	Updated
				min	typ	max	unit			min	typ	max	unit	
			LED Power consumption		TBD	TBD	Watt	11	Power umption		2710	288 0	mWatt	
			LED Life-Time	TBD				LED Life-1	ime	15000				
		25	LVDS Conne	ector 7	Гуре			LVD	S Conr	ector	Туре			Modified
			Type / Part Number	IPEX :		40E-12	or	Type	e / Part ber		20455-0	040E-12/	A or	
		31	Screw Hole Depth and Center Position TBD Screw Hole Depth and Center Position Attached						,	Updated				
		32	Shipping Label F	ormat: T	BD			Shipping Label Format:Added					Updated	
		33	Carton package:	ГBD				Carton package: Added					Updated	
		34	Shipping packag	e of palle	etizing s	equence	:TBD	Shipping package of palletizing sequence:Added					Updated	
		19	6.3 Integration In	terface a	and Pin	Assignm	ent	6.3 Int	egration I	nterface	and Pin	Assignm	nent	Modified
			38 VLED			upply 7V		6.3 Integration Interface and Pin Assignment 38 VLED LED Power Supply 6V-21V						
			39 VLED	LED F	Power Su	upply 7V	-20V	39	VLED	LED	Power S	upply 6V	-21V	
			40 VLED	LED F	Power Su	upply 7V	-20V	40	VLED	LED	Power S	supply 6V	-21V	
		6	Color / Chror	naticit	y Coo	dinates	:TBD		r / Chro linates:		•			Update
			LED Power (Life-Time	Consu	mptio	n and	LED		Power Time	Cons	umptic	n and	LED	Updated
				min	typ	max	unit			min	typ	max	unit	1
			LED Power consumption		2710	2880	mWatt	11	Power umption		2.71	2.76	Watt	
		22	Timing Chara	Timing Characteristics: TBD						Timing Characteristics:Updated				
0.5 2	2009/04/16	15	5.2 Backlight	5.2 Backlight Unit					5.2 Backlight Unit 5.2.1 LED characteristics 5.2.2 Backlight input signal characteristics					Modified
		19	Pin Assignment						Pin Assignment: pin35, 38, 39, 40 description is modified				Modified	
		20	6.5 Power OI	V/OFF	Sequ	ence		6.5 F	ower C	N/OF	F Sequ	ience:	Timing	Modified



								Definition m	odifie	d			
0.6 2009/06/24	16	PWM Input	Frequ	uency				PWM Input	Frequ	ency			Modified
0.0 2003/00/24	'0	Symbol₽	Min∉	Тур₽	Max ₽	Units₽		Symbol∂	Min₽	Тур₽	Max ₽	Units₽	Modifica
		FPWM₽	100₽	-47	10K₽	Hz₽		FPWM₽	990₽	1K₽	10K₽	Hz₽	
0.7 2009/07/10	6	Surface Tre	atme	nt: Re	flection	<4%		Surface Tre	atmer	ıt: Refl	ection -	4.3%	Update
	7							Response t	ime				add
								Conditions	Min.	Ту	p. Ma	ax.	
								Rising	-	3		<u>. </u>	
								Falling	-	5	j .	-	
	15		5.1.2 Signal Electrical Characteristics LVDS Signal Waveform figure					5.1.2 Signal Electrical Characteristics LVDS Signal Waveform figure					Modified
	19	LVDS Conr	necto	r Туре)			LVDS Conr	Update				
		Type / Part Number		X 2045	5-040E-1	2A or		Type / Part Number		(20455 - patible	-040E-12	R or	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B116XW02 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B116XW02 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications						
Screen Diagonal	[mm]	293.83						
Active Area	[mm]	256.125 X	256.125 X 144.0					
Pixels H x V		1366x3(RG	B) x 768					
Pixel Pitch	[mm]	0.1875 x 0.	1875					
Pixel Format		R.G.B. Vert	ical Stripe					
Display Mode		Normally W	hite /					
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	• • •	points avera	• /				
Luminance Uniformity		1.25 max. (5 points)					
Contrast Ratio		500:1 typ						
Response Time	[ms]	8 typ / 16 M	lax					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.						
Power Consumption	[Watt]	4.0 max. (Ir	nclude Logic	and Blu po	wer)			
Weight	[Grams]	255g max.						
Physical Size	[mm]		Min.	Тур.	Max.			
Include bracket		Length	267.5	268.0	268.5			
		Width	161.0	161.5	162.0			
		Thickness	-	-	5.2			
Electrical Interface		1 channel L	_VDS					
Glass Thickness	[mm]	0.5						
Surface Treatment		Glare, Hardness 3H, Reflection 4.3 %						
Support Color		262K colors	s (RGB 6-bi	t)				



°C]	0 to +50
C]	-20 to +60
	RoHS Compliance

2.2 Optical Characteristics

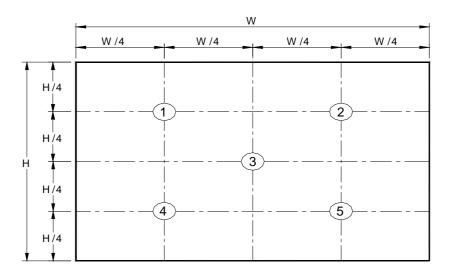
The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	170	200	-	cd/m ²	1, 4, 5.
Viewing A	Viewine Angle		Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degree	
Viewing Ai	igie	ф н ф ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ 5P	5 Points	-	-	1.25		1, 3, 4
Luminan Uniformi		δ 13P	13 Points	-	-	1.60		2, 3, 4
Contrast R	atio	CR		400	500	-		4, 6
Cross ta	Cross talk					4		4, 7
		Tr	Rising	-	3	-		
Response ⁻	Time	T_f	Falling	-	5	-	msec	4, 8
		T _{RT}	Rising + Falling	-	8	16		
	Red	Rx		0.550	0.580	0.610		
	Red	Ry		0.315	0.345	0.375		
	Green	Gx		0.295	0.325	0.355		
Color / Chromaticity	Green	Gy		0.520	0.550	0.580		
Coodinates	Dive	Bx	CIE 1931	0.125	0.155	0.185		4
	Blue	Ву		0.110	0.140	0.170		
	\A/la:4.a	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		

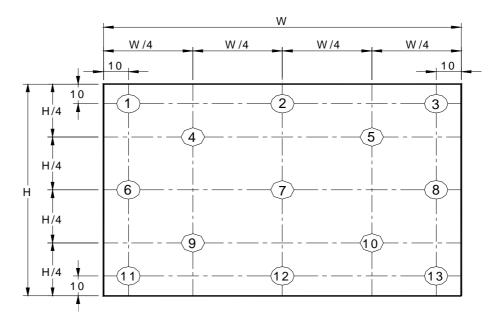


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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

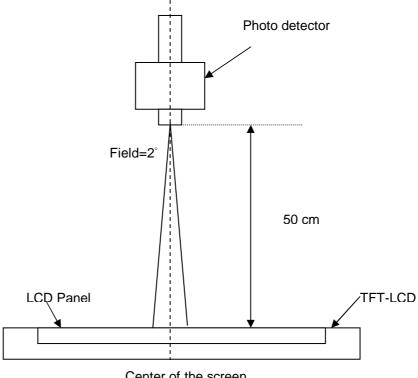
2	Maximum Brightness of five points
δ _{W5} =	Minimum Brightness of five points
9	Maximum Brightness of thirteen points
$\delta_{W13} =$	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after



lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

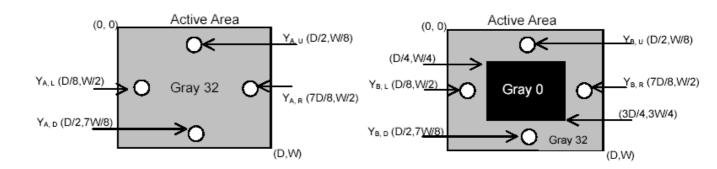
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

 Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

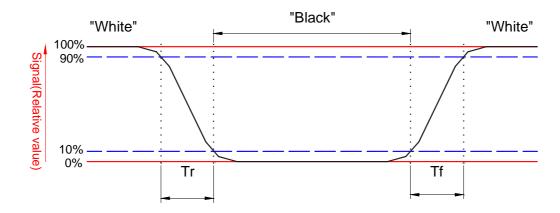
 Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

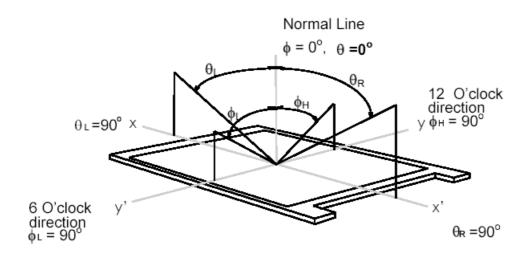




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Note 9. Definition of viewing angle

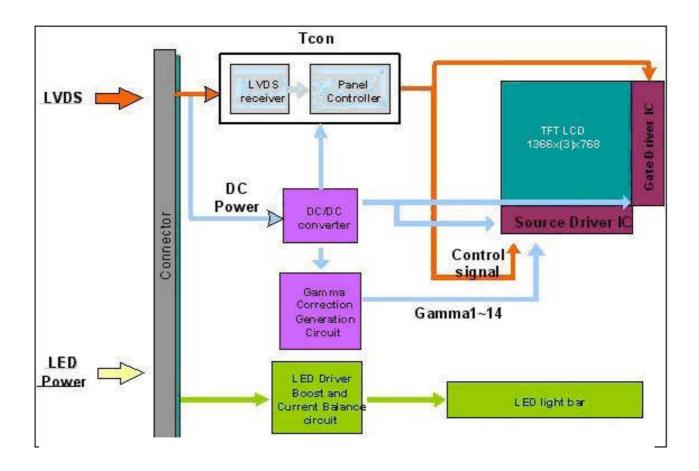
Viewing angle is the measurement of contrast ratio \ge 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 11.6 inches wide Color TFT/LCD 40 Pin one channel Module





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

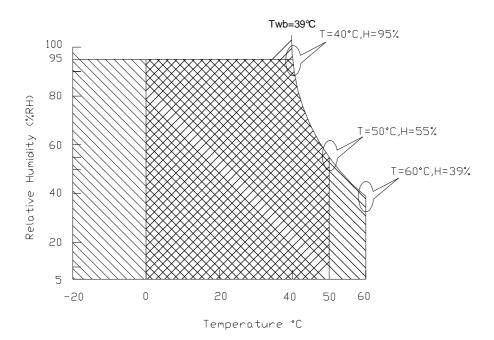
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	ТОР	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

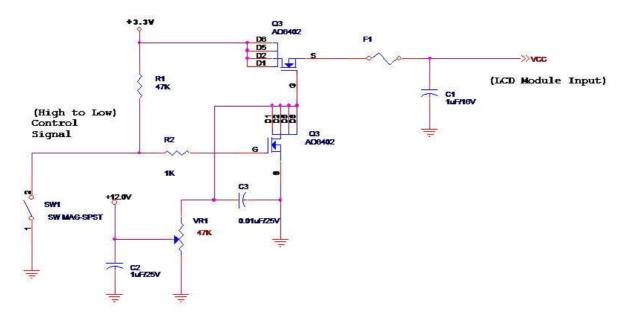
Input power specifications are as follows;

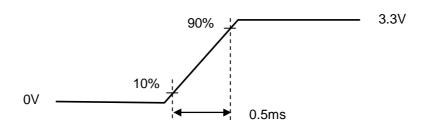
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive	3.0	3.3	3.6	[Volt]	
	Voltage					
PDD	VDD Power	_	-	0.8	[Watt]	Note 1
IDD	IDD Current	-	-	450	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable	_	_	100	[mV]	
	Logic/LCD Drive				р-р	
	Ripple Voltage					

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x Iblack)

Note 2: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

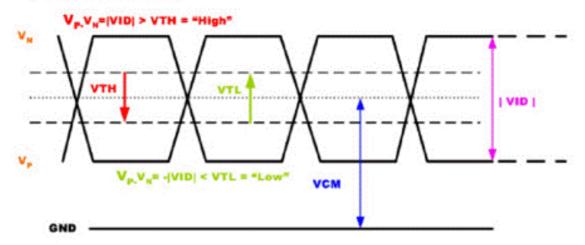
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V_{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform

Single-end Signal





5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.76	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

Note 1: Calculator value for reference $P_{\text{LED}} = VF$ (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	\// ED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level	VPWM EN	2.5	-	5.5	[Volt]	Connector
PWM Logic Input Low Level	_	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	990	1K	10K	Hz	
PWM Duty Ratio	Duty	5		100	%	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1				1366
1st Line	R G B	R G B		R G B	R G B
			•	,	,
	,				.
	•		•	•	
			•		•
			•		
	1	1	1	1	
768th Line	R G B	R G B		R G B	R G B



6.2 The Input Data Format

RxCLKIN	
RxIN0	G0 R5 R4 R3 R2 R1 R0
RxIN1	B1 B0 G5 G4 G3 G2 G1
RxIN2	DE VS HS B5 B4 B3 B2

Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	·
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
IXOLINII	Data Clock	DE signals. All pixel data shall be valid at the
		falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
_ _		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20347-340E-12R or compatible
Mating Housing/Part Number	IPEX 20345-340E-12 or compatible

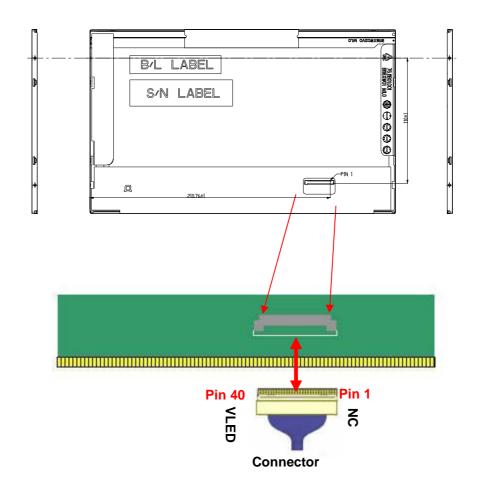
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connect (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT
19	VSS	Ground
20	NC	No connection
21	NC	No connection
22	NC	No connection



23	NC	No connection
24	NC	No connection
25	NC	No connection
26	NC	No connection
27	NC	No connection
28	NC	No connection
29	NC	No connection
30	NC	No connection
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	VPWM_EN	PWM logic input level
36	VLED_EN	LED enable input level
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply
39	VLED	LED Power Supply
40	VLED	LED Power Supply





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Note1: Input signals shall be low or High-impedance state when VDD is off.

6.4 Interface Timing

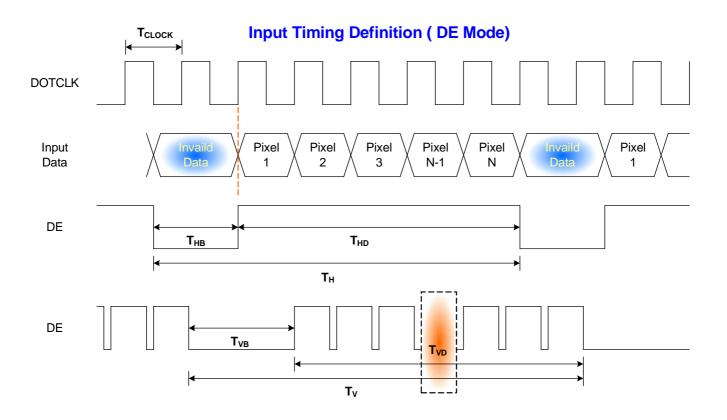
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	Frame Rate		50 60 -		Hz	
Clock from	Clock frequency		50	72	1	MHz
Period		T _V	803	•	1023	
Vertical	Active	T _{VD}	768		T_{Line}	
Section	Blanking	T_{VB}	35	-	255	
	Period	T _H	1494	-	2047	
Horizontal	Active	T _{HD}		1366		T_{Clock}
Section	Blanking	T _{HB}	128	-	681	

Note: DE mode only

6.4.2 Timing diagram

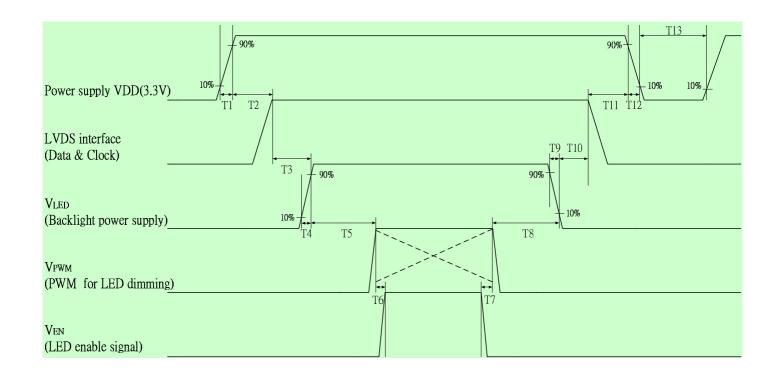




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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing							
Parameter	Min.	Тур.	Max.	Units			
T1	0.5	-	10				
T2	0	-	50				
Т3	200	-	-				
T4	0.5	-	10				
Т5	10	-	-				
Т6	10	-	-				
Т7	0	-	-	ms			
Т8	10	-	-				
Т9	0	-	10				
T10	200	-	-				
T11	0.5	-	50				
T12	0	-	10				
T13	400	-	-				

Note:If T3,T5,T6 couldn't match above specifications, must request <u>T3+T5+T6 > 200ms</u> at least



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

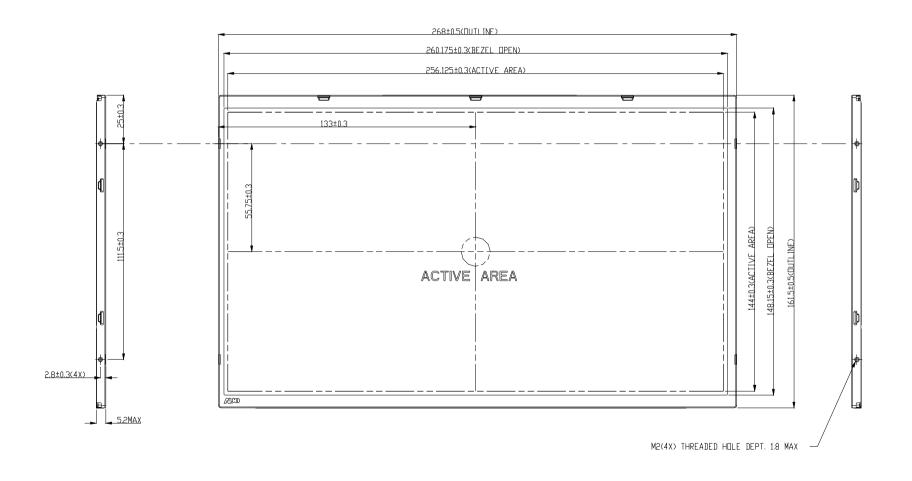
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



AU OPTRONICS CORPORATION

8. Mechanical Characteristics

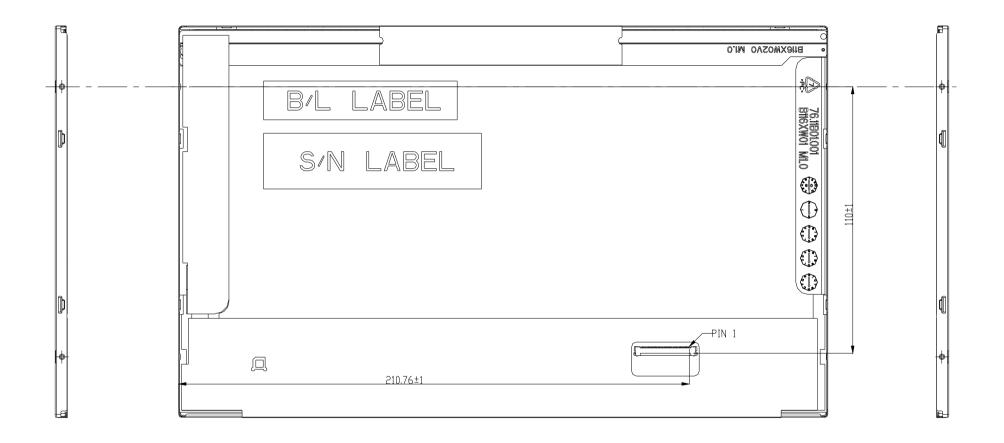
8.1 LCM Outline Dimension



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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

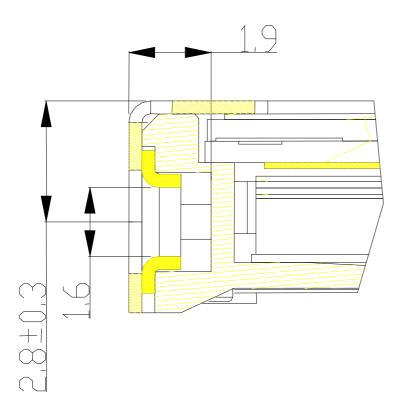


8.2 Screw Hole Depth and Center Position

Maximum Screw penetration from side surface is 1.9 mm

The center of screw hole center location is 2.8 \pm 0.3mm from front surface

Screw Torque: Maximum 2.5 kgf-cm





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- 9. Shipping and Package
- 9.1 Shipping Label Format



Manufactured MMAVW Model No: B116XW02 AU Optronics MADE IN CHINA (\$01)

HW: 0A FW:1

xxxxxx **OAXXG**

V.O

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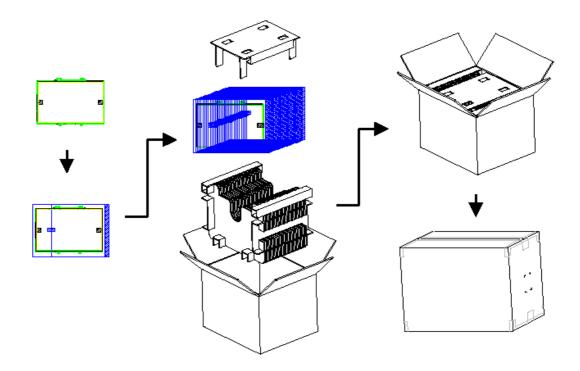




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9.2 Carton Package

The outside dimension of carton is 405(L)mm* 375(W)mm* 268(H)mm, carton and cushion weight are 2080g

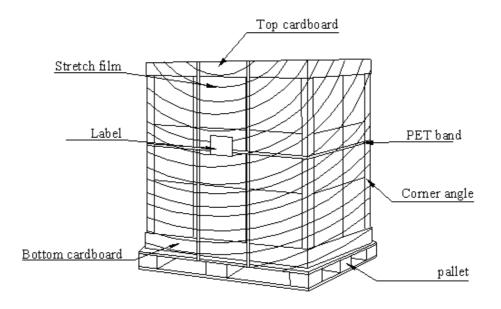


9.3 Shipping Package of Palletizing Sequence

The outside dimension of Pallet is 114(L)mm* 89(W)mm* 13.8(H)mm

By air : 6 *5 layers, one pallet put 30 boxes, total 900 pcs module.

By sea: 6 *7 layers, one pallet put 42 boxes, total 1260 pcs module.





10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	0000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	5C	01011100	92	
0B	hex, LSB first	20	00100000	32	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	12	00010010	18	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	1A	00011010	26	
16	Max V image size (rounded to cm)	0E	00001110	14	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	99	10011001	153	
1 A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	56	01010110	86	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	0000000	0	



	AU OPTRON		L	1	1
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	0000001	1	
27		01	0000001	1	
28	Standard timing #2	01	0000001	1	
29		01	0000001	1	
2A	Standard timing #3	01	0000001	1	
2B		01	0000001	1	
2C	Standard timing #4	01	0000001	1	
2D		01	0000001	1	
2E	Standard timing #5	01	0000001	1	
2F		01	0000001	1	
30	Standard timing #6	01	0000001	1	
31		01	0000001	1	
32	Standard timing #7	01	0000001	1	
33		01	0000001	1	
34	Standard timing #8	01	0000001	1	
35		01	0000001	1	
36	Pixel Clock/10000 LSB	20	00100000	32	
37	Pixel Clock/10000 USB	1C	00011100	28	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	80	10000000	128	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	23	00100011	35	
20	Vert Act : Vertical Blanking	20	00440000	40	
3D	(upper 4:4 bit) HorzSync. Offset	30	00110000	48	
3E	HorzSync.Width	30	00110000	48	
3F	VertSync.Offset : VertSync.Width	20	00100000	32	
40	Horz‖ Sync Offset/Width Upper	36	00110110	54	
41	2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	00	00000000	0	
43	Vertical Image Size Lower 8bits	90	10010000	144	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	0000000	0	
46	Vertical Border (zero for internal LCD)	00	0000000	0	
	Signal (non-intr, norm, no stero, sep sync,				
47	neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	



				_	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	0000000	0	
6D	descriptor #4	00	00000000	0	
6E	doonplot # 1	00	00000000	0	
6F		FE	11111110	254	
70		00	0000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	31	00110001	49	1
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	32	00110010	50	2



7E 7F	Checksum	BE	10111110	190	
7E	Extension Flag	00	00000000	0	
7D		0A	00001010	10	
7C		20	00100000	32	
7B	Manufacture P/N	30	00110000	48	0
7A	Manufacture P/N	56	01010110	86	V
79	Manufacture P/N	20	00100000	32	

SUM to HEX 1700